



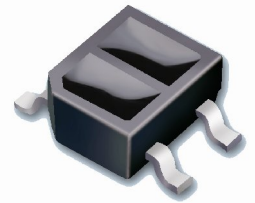
Technical Data Sheet

Opto Interrupter ITR

ITR8307/L24/TR8

Features

- High sensitivity
- Cut-Off visible wavelength
- Thin
- Compact
- Pb free



Descriptions

ITR8307/L24/TR8 is a light reflection switch which includes a GaAs IR-LED transmitter and a NPN photo-darlington with a high photosensitive receiver for short distance, operating in the infrared range. Both components are mounted side-by-side in a plastic package.

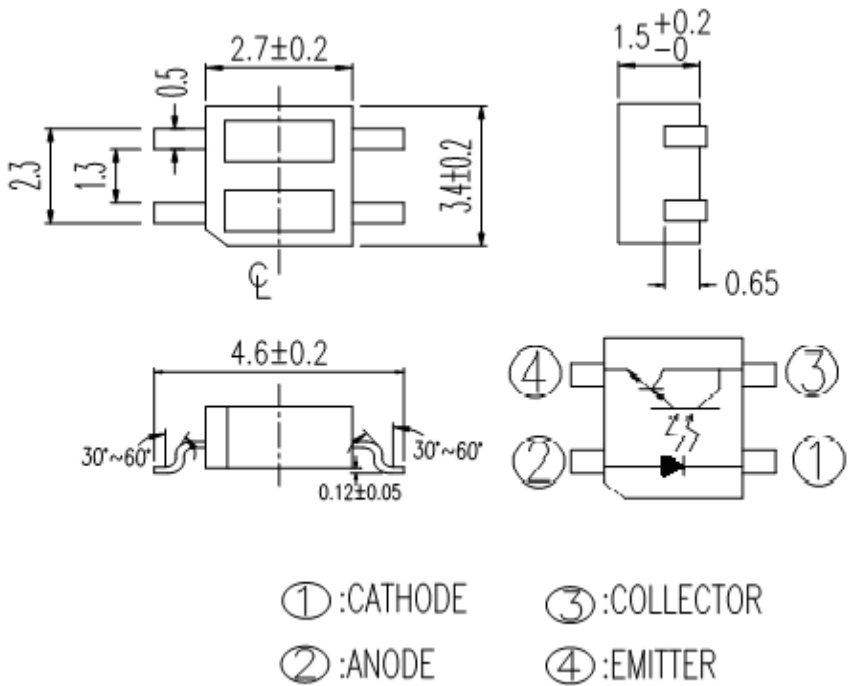
Applications

- Camera
- VCR
- Floppy disk driver
- Cassette type recorder
- Various microcomputer control equipment

Device Selection Guide

| Device No. | Chip Material |
|------------|---------------|
| IR | GaAs |
| PT | Silicon |

Package Dimensions



- Notes:** 1.All dimensions are in millimeters
 2.Tolerances unless dimensions ± 0.25 mm

Absolute Maximum Ratings (Ta=25)

| Parameter | | Symbol | Ratings | Unit |
|---------------------------------|---|--------------------|---------|------|
| Input | Power Dissipation at(or below) 25 Free Air Temperature | Pd | 75 | mW |
| | Reverse Voltage | V _R | 6 | V |
| | Forward Current | I _F | 50 | mA |
| | Peak Forward Current (*1) Pulse width 100μs, Duty cycle=1% | I _{FP} | 1 | A |
| Output | Collector Power Dissipation | P _C | 100 | mW |
| | Collector Current | I _C | 20 | mA |
| | Collector-Emitter Voltage | B V _{CEO} | 15 | V |
| | Emitter-Collector Voltage | B V _{ECO} | 6 | V |
| Operating Temperature | | Topr | -25~+85 | |
| Storage Temperature | | Tstg | -30~+90 | |
| Lead Soldering Temperature (*2) | | Tsol | 260 | |

(* 1) tw=100 μsec. , T=10 msec. (* 2) t 10 Sec

Electro-Optical Characteristics (Ta=25)

| Parameter | | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|--------------------------|-------------------|---------------|------|------|------|---------|--------------------------------------|
| Input | Forward Voltage | V_F | - | 1.2 | 1.4 | V | $I_F=20mA$ |
| | Reverse Current | I_R | - | - | 10 | μA | $V_R=6V$ |
| | Peak Wavelength | λ_P | - | 940 | - | nm | - |
| Output | Dark Current | I_{CEO} | - | - | 1 | μA | $V_{CE}=10V,$ $E_e=0mW/cm^2$ |
| Transfer Characteristics | Collector Current | $I_{C(ON)}^*$ | 0.5 | - | 15.0 | mA | $V_{CE}=2V,$ $I_F=4mA$ |
| | Leakage Current | I_{CEOD} | - | - | 5 | μA | $V_{CE}=2V,$ $I_F=4mA$ $d=1mm$ |
| | Rise time | t_r | - | - | 400 | μs | $V_{CE}=2V$ $I_C=10mA$ |
| | Fall time | t_f | - | - | 400 | μs | $R_L=100\Omega,$ $d=1mm$ |

* : Reflector is Al deposited glass.

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Typical Electrical/Optical/Characteristics Curves for IR

Fig. 1 Forward Current vs. Ambient Temperature

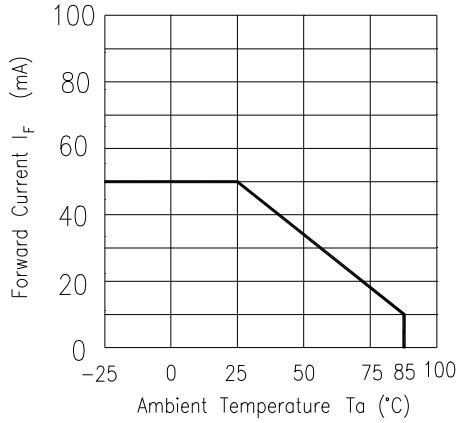


Fig. 2 Spectral Distribution

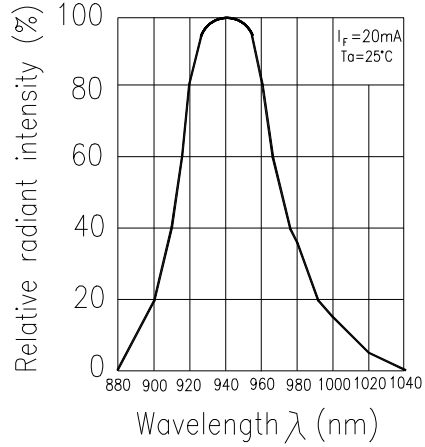


Fig. 3 Peak Emission Wavelength vs. Ambient Temperature

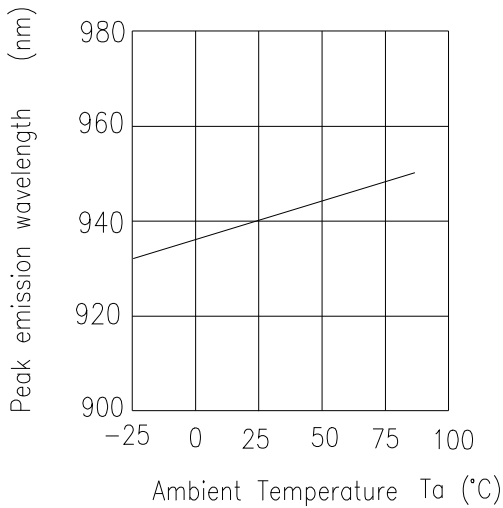


Fig. 4 Forward Current vs. Forward Voltage

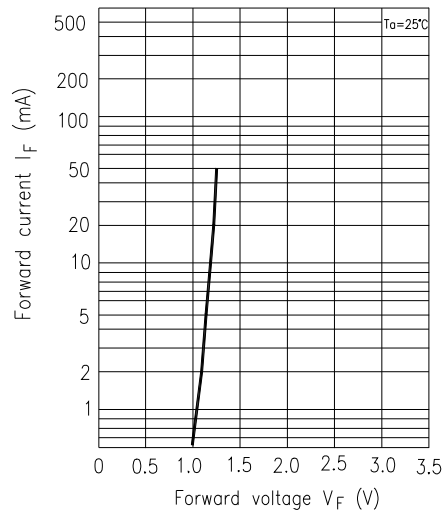


Fig. 5 Forward Voltage vs. Ambient Temperature

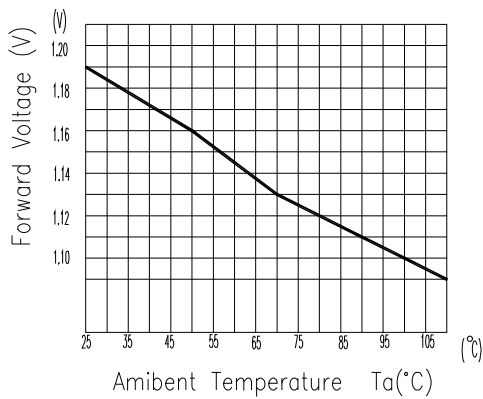
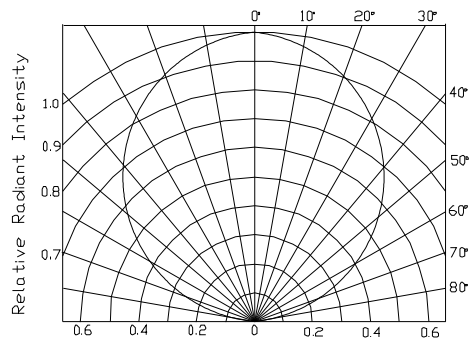
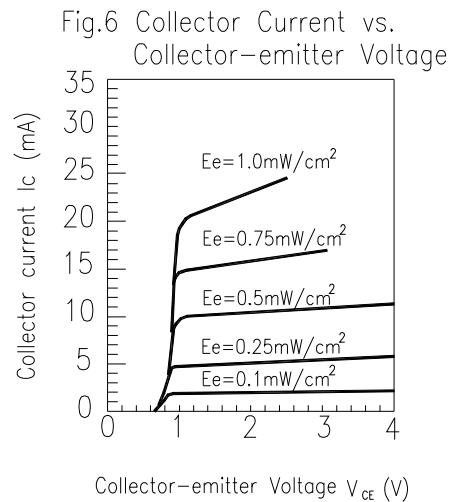
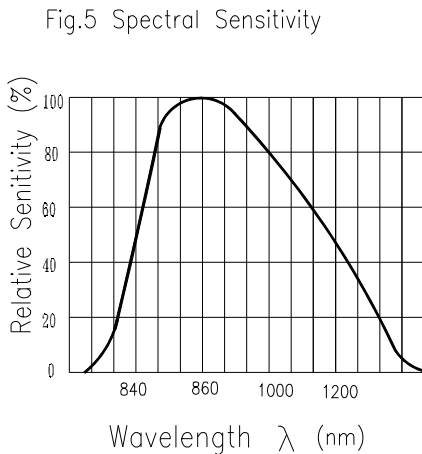
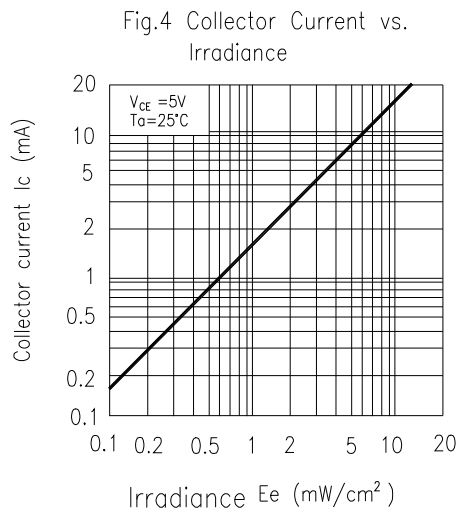
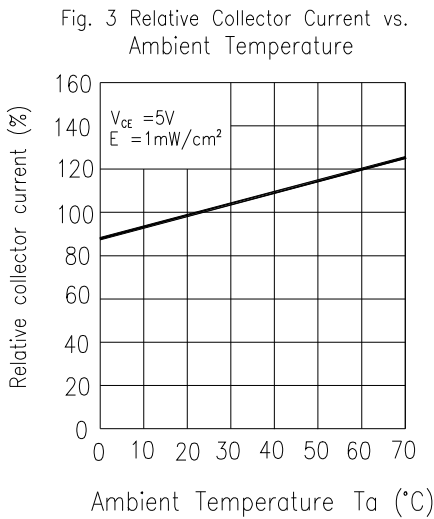
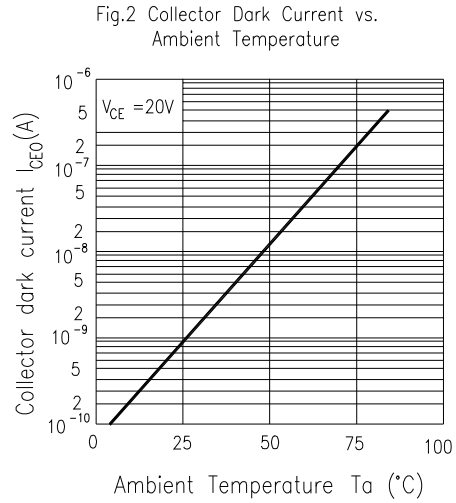
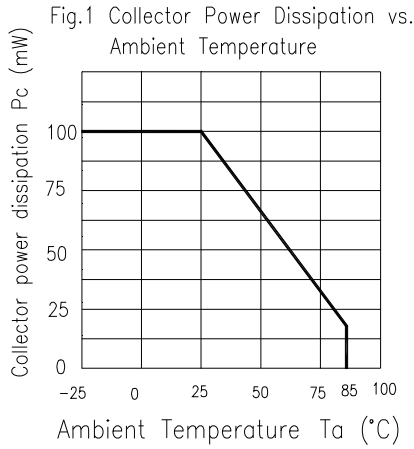


Fig. 6 Relative Radiant Intensity vs. Angular Displacement



Typical Electrical/Optical/Characteristics Curves for PT



Typical Electrical/Optical/Characteristics Curves for ITR

Fig.7 Relative Collector Current vs. Distance between Sensor and Al Evaporation Galss

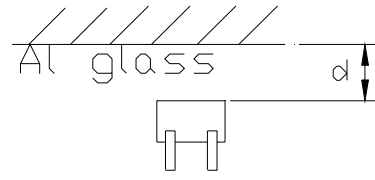
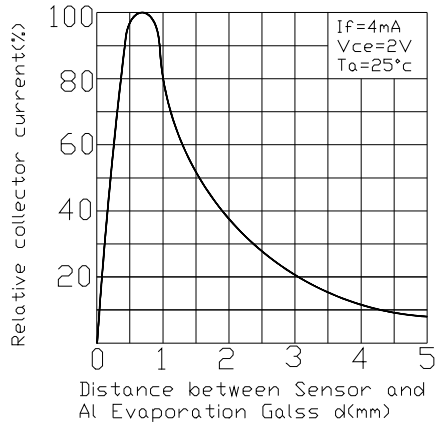
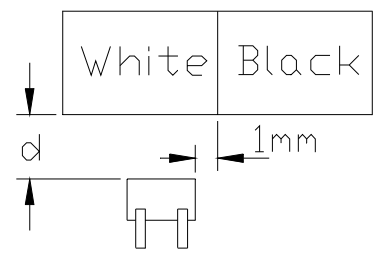
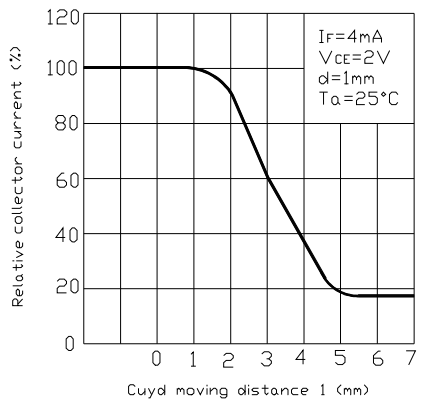


Fig.8 Relative Collector Current vs. Card Moving Distance (l)



Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

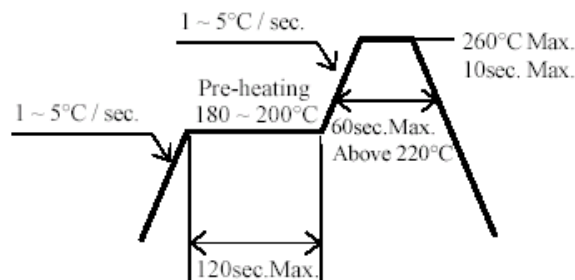
| NO. | Item | Test Conditions | Test Hours/ Cycles | Sample Sizes | Failure Judgement Criteria | Ac/Re |
|-----|------------------------------------|---|-----------------------|-----------------|--|-------|
| 1 | Solder Heat | TEMP. : 260 ±5 | 10secs | 22pcs | I _R U×2 E _e L×0.8 V _F U×1.2 U : Upper Specification Limit L : Lower Specification Limit | 0/1 |
| 2 | Temperature Cycle | H : +85 30mins ↑ 5mins ↓ L : -25 30mins | 50Cycles | 22pcs | | 0/1 |
| 3 | Thermal Shock | H : +100 5mins ↑ 10secs ↓ L : -10 5mins | 50Cycles | 22pcs | | 0/1 |
| 4 | High Temperature Storage | TEMP. : +100 | 1000hrs | 22pcs | | 0/1 |
| 5 | Low Temperature Storage | TEMP. : -30 | 1000hrs | 22pcs | | 0/1 |
| 6 | DC Operating Life | I _F =20mA | 1000hrs | 22pcs | | 0/1 |
| 7 | High Temperature/ High Humidity | 85 / 85% R.H | 1000hrs | 22pcs | | 0/1 |

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Recommended Method of Storage

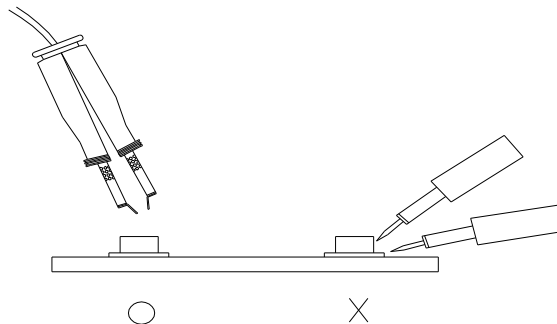
The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

- Shelf life in sealed bag: 12 months at $< 40\text{ }^{\circ}\text{C}$ and $< 90\%$ relative humidity (RH)
- After bag is opened, devices that will be subjected to reflow solder or other high temperature process must
 - a) Mounted within 72 hours of factory conditions $< 30\text{ }^{\circ}\text{C}/60\%$ RH, or
 - b) Stored at $< 20\%$ RH
- Devices require bake, before mounting, if:
 - Humidity Indicator Card is $> 20\%$ when read at $23 \pm 5\text{ }^{\circ}\text{C}$
- If baking is required, devices may be baked:
 - a) 192 hours at $40\text{ }^{\circ}\text{C}$, and $< 5\%$ RH(dry air/nitrogen) or
 - b) 96 hours at $60\text{ }^{\circ}\text{C}$, and $< 5\%$ RH for all device containers
 - c) 24 hours at $125\text{ }^{\circ}\text{C}$
- Soldering Condition
 - a) Pb-free solder temperature profile

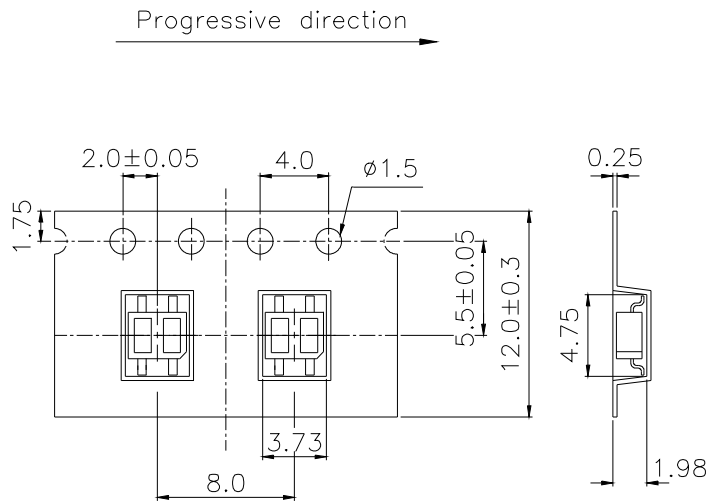


- b) Reflow soldering should not be done more than two times.
 - c) When soldering, do not put stress on the LEDs during heating.
 - d) After soldering, do not warp the circuit board.
- Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

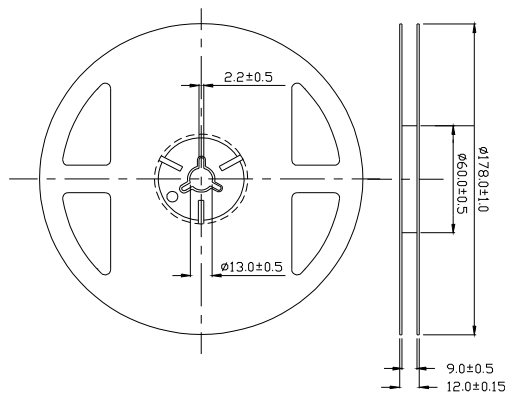


Taping Dimension



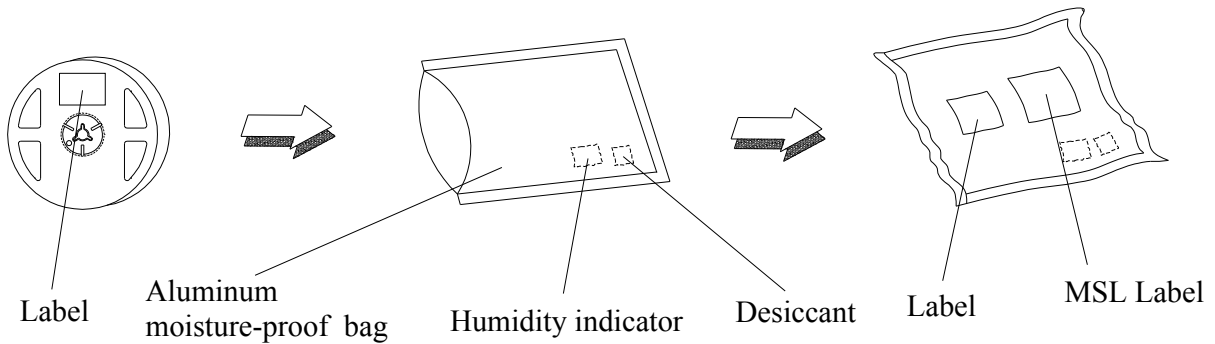
General Tolerance ± 0.1
UNIT:mm

Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

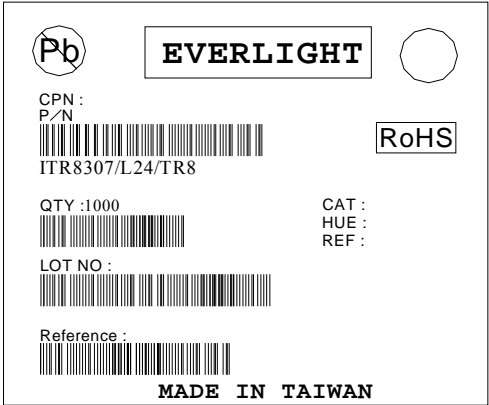
Moisture Resistant Packaging



Packing Quantity Specification

- 1. 1000 Pcs/ 1Reel
- 2. 15 Reel /1 Box
- 3. 2 Box/ 1 Carton

EVERLIGHT Label



CPN: Customer's Production Number
P/N : Production Number
QTY: Packing Quantity
CAT: None
HUE: None
REF: Reference
LOT No: Lot Number
MADE IN TAIWAN: Production Place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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| | |
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|---|--|



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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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